

PRODUCT / PROCESS CHANGE NOTIFICATION PCN-000899

Date: NOV-08-2023

| | Chang | e Details | |
|---|---|--|---|
| Part Number(s) Affect | ed: Cu | ıstomer Part Number(s) Af | fected: N/A |
| | | | |
| GN1444SI | | | |
| GN1444SI | | | |
| GN2044SI | | | |
| GN2044SI | | | |
| GS6151-ไก้ GS6151-ไก้ | | | |
| GS6151-II GS6151-II | | | |
| וו-ו כו טכט | NIESZ | | |
| Description, Purpose a | nd Effect of Change: | | |
| DUAL SOURCING | | | |
| In order to improve supply of source for the affected part by ASEM in Malaysia. Final test is still performed to changes to the test platform | numbers listed above. This char by ASE in Malaysia for GS6151 a n or test programs. | ntech has qualified GREATEK in T nge applies to 32MLPQ 4x4mm p and KYEC in Taiwan for GN1444S pages show that there are few d | ackages, currently assembled and GN2044S. There are no |
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performance, characteristics, or reliability.

Overall qualification meets the requirements for assembly, testing, and reliability. The change has no effect on



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| Implementation Date | JAN-31-2024 | Work Week | 05 |
|---|----------------------------|--|-------------|
| Last Time Ship (LTS) Of unchanged product | N/A | Affecting Lot No. / Serial No. (SN) | N/A |
| Sample Availability | OCT-13-2023 GN1444SINE3 | Qualification Report Availability | OCT-13-2023 |

Supporting Documents for Change Validation/Attachments:

• PRODDOC029958 Reliability Qualification Report

| Quality Assurance | | | | |
|-----------------------|--|--|--|--|
| Semtech | Signal Integrity Droduct Croup | | | |
| Business Unit | Signal Integrity Product Group | | | |
| Semtech Contact Info: | Pedro Jr. Bernas pbernas@semtech.com (289) 856-9326 x 1162 | | | |

FOR FURTHER INFORMATION & WORLDWIDE SALES COVERAGE: http://www.semtech.com/contact/index.html#support

COMPARISONS

> MATERIAL

| Material | Current Source ASEM | Second Source GREATEK | |
|---------------|------------------------|----------------------------|--|
| Lead frame | QPL | Chang Wah Elec. (Sumitomo) | |
| Ероху | Hitachi HR-5104T | Nitto EM430 | |
| Mold compound | EME G770HCD | EME G700H | |
| Wire | 1.0mil CuPd | 1.0mil CuPd | |

^{*} The BOM (Bill of Material) for Greatek is qualified and running at high volume in mass production.

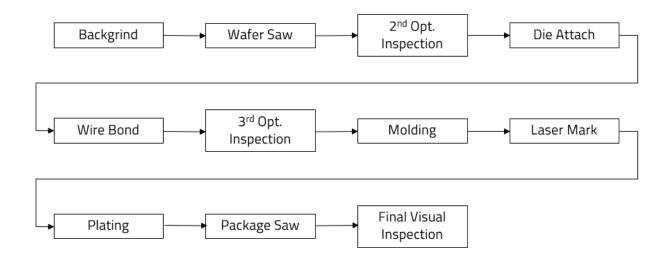


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> PROCESS FLOW

o GREATEK and ASEM follow the same process flow, which is outlined below.



EQUIPMENT

• Equipment in GREATEK and ASEM is standard mass production equipment that can meet package requirements.

| | Current Source | Second Source | |
|----------------|------------------|-------------------------------------|--|
| Process step | ASEM | GREATEK | |
| Backgrind | Disco PG300RMA | Disco DFG 850, 8540, 8560 | |
| Wafer saw | Disco D641 | Disco DFD-6340, 6361, 6560 | |
| Die attach | ASM 898 | BESI 2100 series | |
| Wire bond | KNS Maxum series | KNS & ESEC Iconn, ProCu, 3100, 3200 | |
| Molding | Daiichi GP-PR08 | TOWA Y1 | |
| Package Sawing | Disco D6340 | TOWA FMS 3040 | |



Reliability Qualification Report for 4x4mm 32L QFN package Products at Greatek

Revision History

| Version | ECO | Date | Modifications |
|---------|------------|--------------|---------------|
| 0 | ECO-068750 | October 2023 | New Release |

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1 Background

Semtech's 4x4mm 32L QFN package products are currently being assembled in ASEM, and FT at KYEC. To meet customer demand and to ensure timely delivery, a dual source qualification at Greatek was initiated. The purpose of this qualification is to qualify Greatek as a second assembly site for 4x4mm 32L QFN products.

2 Product Scope

A total of 7 products will be affected by this process change. The products affected, and their package type, are listed in table 1

Table 1: all products covered in this qualification and their package type.

| Products | Package type | Qualification Vehicle |
|---------------|---------------|-----------------------|
| GN1444SINE3 | 4x4mm 32L QFN | |
| GN1444SINTE3D | 4x4mm 32L QFN | |
| GN2044SINE3 | 4x4mm 32L QFN | |
| GN2044SINTE3D | 4x4mm 32L QFN | GN1444S-IE3 |
| GS6151-INE3 | 4x4mm 32L QFN | |
| GS6151-INTE3 | 4x4mm 32L QFN | |
| GS6151-INTE3Z | 4x4mm 32L QFN | |

3 Qualification Approach

All products listed in table 1 have already been fully qualified previously (see table 2 for product document number of each qualification report). Out of all affected products, GN1444S-IE3 was selected as qualification vehicle based on their package size/type and sales volume. This qualification only intends to assess the reliability impact of having 4x4mm 32L QFN products assembled at Greatek. Thus, die-level reliability stresses (HTOL, ESD and LU) were not planned. TC, UHAST and HTS were carried out on three lots of each product. CSAM was performed on 22 randomly selected parts from each lot and stresses at T0, post MSL (if applicable) and post stresses. For more information about the conditions of the qualification stresses and sample size, please refer to table 3 in section 4.

Table 2: product document number of qualification reports for all product affected by this process change.

| Product | Qualification Report | |
|---------------|----------------------|--|
| GN1444SINE3 | | |
| GN1444SINTE3D | PRODDOC009414 | |
| GN2044SINE3 | | |
| GN2044SINTE3D | | |
| GS6151-INE3 | | |
| GS6151-INTE3 | PRODDOC010454 | |
| GS6151-INTE3Z | | |

4 Reliability Qualification Stresses

Table 3: Reliability qualification stresses for GN1444S-IE3 assembled at Greatek

| Stress Test | Conditions | Duration | Qualification Vehicle | Sample Size | Result |
|-----------------------------------|--|------------|-----------------------|----------------------|--------|
| High Temperature Storage (HTS) | JESD22-A103 MSL1 preconditioning and CSAM T=150 °C | 500 hours | GN1444S-IE3 | 80 pcs/lots (3 lots) | Pass |
| UHAST | JESD22-A118 MSL1 preconditioning and CSAM 130°C, 85 % RH, | 96hrs | GN1444S-IE3 | 80 pcs/lots (3 lots) | Pass |
| тс | JESD22-A104 MSL1 preconditioning and CSAM -40°C to +125°C | 500 cycles | GN1444S-IE3 | 80 pcs/lots (3 lots) | Pass |

5 Conclusion

In conclusion, GN1444S-IE3 assembled at Greatek successfully passed required reliability stresses. Thus, Greatek can be considered as a qualified assembly site for Semtech's 4x4mm 32L QFN products.